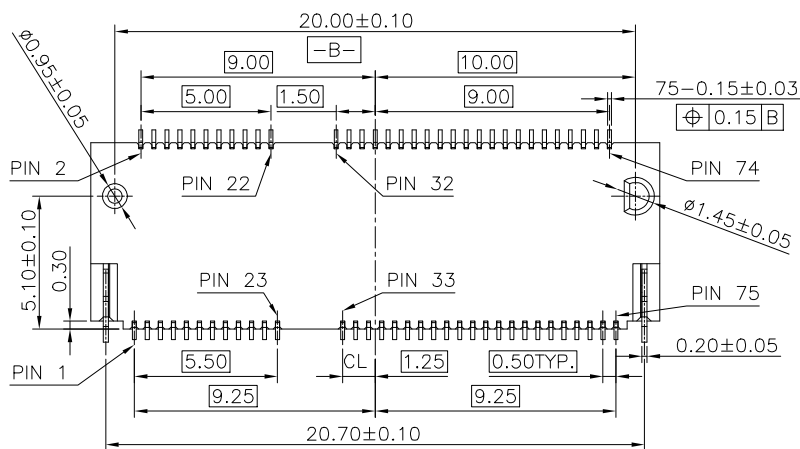


TABLE:

NO.	PART NO.	DESCRIPTION	DURABILITY
1	26009-S20003BGF00R	GOLD G/F ON CONTACT AREA	25 CYCLES
		GOLD G/F ON SOLDER AREA	
2	26009-S20003BG600R	GOLD 10u" ON CONTACT AREA	25 CYCLES
		GOLD G/F ON SOLDER AREA	
3	26009-S20003BG700R	GOLD 15u" ON CONTACT AREA	25 CYCLES
		GOLD G/F ON SOLDER AREA	
4	26009-S20003BG800R	GOLD 30u" ON CONTACT AREA	60 CYCLES
		GOLD G/F ON SOLDER AREA	
5	26009-S20003BGF00R	GOLD G/F ON CONTACT AREA	25 CYCLES
		80u" MIN. MATTE TIN ON SOLDER AREA	
6	26009-S20003BGF00R	GOLD 10u" ON CONTACT AREA	25 CYCLES
		80u" MIN. MATTE TIN ON SOLDER AREA	
7	26009-S20003BG700R	GOLD 15u" ON CONTACT AREA	25 CYCLES
		80u" MIN. MATTE TIN ON SOLDER AREA	
8	26009-S20003BG800R	GOLD 30u" ON CONTACT AREA	60 CYCLES
		80u" MIN. MATTE TIN ON SOLDER AREA	

Notes:

- MATERIAL SPECIFICATION:
 - HOUSING:LCP+40%GF,UL94V-0,COLOR:BLACK.
 - CONTACT:COPPER ALLOY.
 - PEG:STEEL.
- PLATING SPECIFICATION:
 - CONTACT:50u" MIN.NICKEL UNDER PLATING OVER ALL.PLATING ON SOLDER AREA:SEE TABLE
GOLD PLATING ON CONTACT AREA:SEE TABLE
 - PEG:50u" MIN. NICKEL UNDER PLATING OVER ALL.
80u" MIN. MATTE TIN PLATING ON SOLDER AREA.
- HF COMPLIANT, RoHS COMPLIANT.
- MECHANICAL PERFORMANCE:
 - DURABILITY: SEE TABLE
- ELECTRICAL PERFORMANCE:
 - CURRENT: 0.5A PER PIN.
 - LLCR: INITIAL 55mΩ MAX.;FINAL ΔLLCR=20mΩ MAX.
- IR REFLOW:
THE TEMPERATURE SHALL BE 260±5°C MAINTAINING 10±1 SECONDS.

RoHS
Compliant
2013/95/EC



CUSTOMER DRAWING		 连兴旺电子(深圳)有限公司 connectivity LXWCONN ELECTRONICS (SHENZHEN) CO., LTD				
GENERAL TOLERANCE .X ±0.35 .XX ±0.25 .XXX ±0.15 ANGLE ±1°		DESIGN Tan 2026.04.30	TITLE 0.5 PITCH M.2 H4.2(KEY E)			
CHECKED		PART NO. 26009-S20003BXX00R				
SIZE A4		APPROVAL	SCALE 1:1	UNITS MM	REV. A	SHEET 2 OF 5

